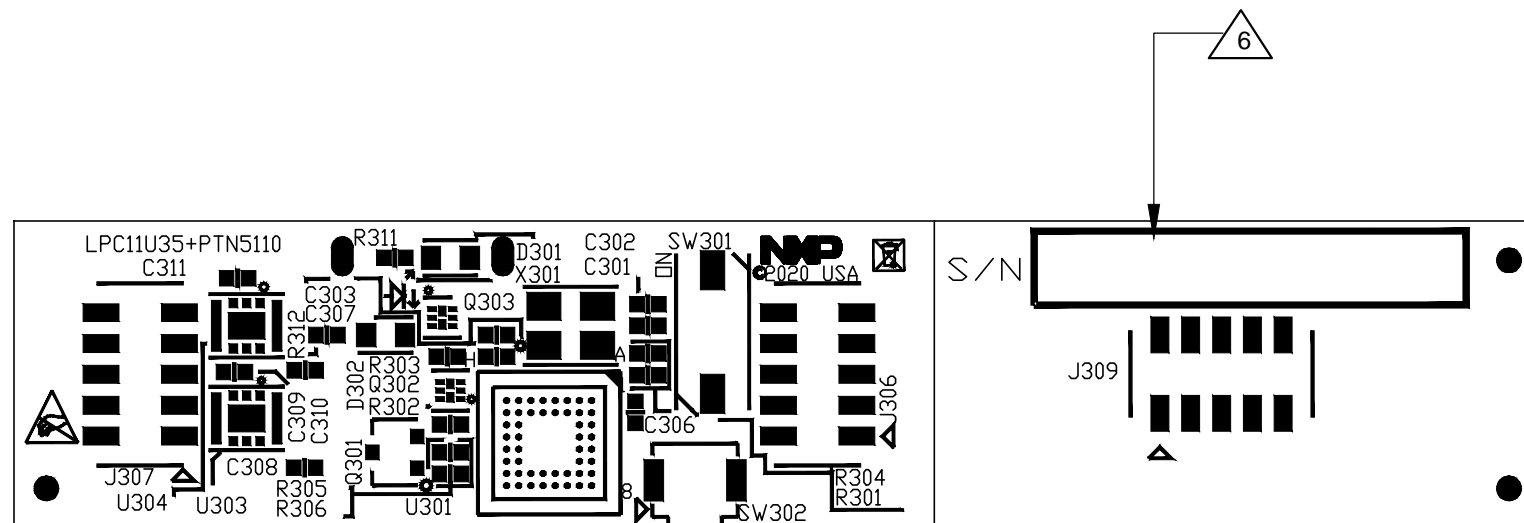


NOTES : TRIANGLE SYMBOLS IDENTIFY NOTES ON THIS DRAWING.

REVISIONS				
ZONE	REV	DESCRIPTION	DATE	APPROVED
	X1	PROTO RELEASE	11/24/20	B.Z



NOTES:


1. ALL COMPONENTS MUST BE ABLE TO WITHSTAND THE Pb-FREE ASSEMBLY PROFILES DESCRIBED IN IPC/JEDEC J-STD-020C (LATEST VERSION)
  2. WORKMANSHIP SHALL CONFORM TO IPC-A-610 (LATEST REVISION) - CLASS 2 STANDARD.
  3. PART SUBSTITUTION CRITERIA : -  
ALL COMPONENT SUBSTITUTIONS MUST BE APPROVED AND DOCUMENTED BY NXP.
  4. MAXIMUM LEAD PROTRUSION ON PRIMARY AND SECONDARY SIDE OF PRINTED WIRING BOARD IS .100".
  5. IN CASES OF CONFLICT, ALL PLACEMENT LOCATIONS ARE TO BE GOVERNED BY THE X-Y CENTROID FILE, UNLESS EXPLICITLY STATED IN THIS ASSEMBLY DRAWING.
- SILKSCREEN REFERENCE DESIGNATORS ARE INCLUDED FOR CONVENIENCE ONLY.

6. PLACE PRINTED SERIAL NUMBER LABEL (805-76760) WHERE SHOWN.

## PRIMARY SIDE

**RoHS** : ALL PARTS, MATERIALS AND FINISHED ASSEMBLY SHALL MEET THE RoHS COMMISSION DELEGATED DIRECTIVE (EU) 2015 / 863 OF MARCH 31 2015 AMENDING ANNEX II TO DIRECTIVE 2011 / 65 / EU. A CERTIFICATE OF COMPLIANCE IS REQUIRED UPON REQUEST.

**REACH** : ALL PARTS, MATERIALS AND FINISHED ASSEMBLY SHALL NOT CONTAIN ANY OF THE SUBSTANCES OF VERY HIGH CONCERN (SVHC) ABOVE THE THRESHOLD VALUE PER THE CURRENT ECHA LIST OF SVHC'S, AND WITH THE ANNEX XIV OF REACH DIRECTIVE 76 / 769 / EEC.. A CERTIFICATE OF COMPLIANCE IS REQUIRED UPON REQUEST.

<b>SOLDER PROCESS</b> <b>Pb FREE</b> <input checked="" type="checkbox"/> <b>YES</b> <input type="checkbox"/> <b>NO</b>		PART NO. <b>700-4770</b>		 <b>NXP Semiconductors</b> 6501 WILLIAM CANNON DRIVE AUSTIN, TEXAS 78735-8598 USA	
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES. TOLERANCES ARE: DECIMALS .XX ±.020 .XXX ±.010 <input checked="" type="checkbox"/> RMS ALL MACHINED SURFACES BREAK ALL SHARP EDGES AND CORNERS, REMOVE BURRS. UNDERLINED DIM. NOT TO SCALE. THIRD ANGLE ORTHOGRAPHIC PROJECTION IS USED.		THIS DOCUMENT CONTAINS INFORMATION PROPRIETARY TO NXP AND SHALL NOT BE USED FOR ENGINEERING DESIGN, PROCUREMENT OR MANUFACTURE IN WHOLE OR IN PART WITHOUT THE CONSENT OF NXP			
<b>MATERIAL</b>		APPROVALS DRAWN <b>DELEEP V</b>		DATE <b>11/24/20</b>	
<b>FINISH</b>		CHECKED <b>BOBBY Z</b>		<b>11/24/20</b>	
<b>HEAT TREAT</b>		DESIGN ENGINEER <b>HELEN X</b>		<b>11/24/20</b>	

TITLE <b>PWB ASSEMBLY</b> <b>X-PTN38007-BASE</b>			
SIZE <b>B</b>	FILE NAME <b>ASY-4770.DXF</b>	DWG. NO. <b>ASY-4770</b>	REV <b>X1</b>
SCALE 1:1	DO NOT SCALE DRAWING		SHEET 1 OF 2

